30V N-Channel PowerTrench[®] MOSFET

General Description

FAIRCHILD

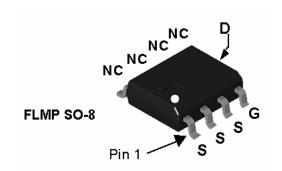
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{\text{DS}(\text{ON})}$ and fast switching speed.

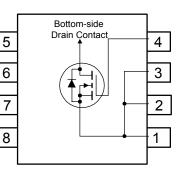
Applications

- DC/DC converter
- Power management
- Load switch

Features

- 14 A, 30 V $R_{DS(ON)} = 9 m\Omega @ V_{GS} = 10 V$ $R_{DS(ON)} = 12 m\Omega @ V_{GS} = 4.5 V$
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability
- Fast switching
- FLMP SO-8 package: Enhanced thermal performance in industry-standard package size





Absolute Maximum Ratings T_A=25°C unless otherwise noted

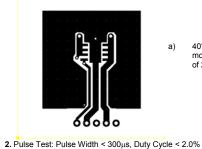
Symbol	Parameter			Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V	
V _{GSS}	Gate-Source Voltage			±20	V
I _D	Drain Current – Continuous (Note 1a)		14	А	
		 Pulsed 		60	
PD	Power Dissipation for Single Operation (Note 1a)		3.0	W	
			(Note 1b)	1.5	
T_J, T_{STG}	Operating and Storage Junction Temperature Range			–55 to +150	°C
Therma	l Charac	teristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)		40	°C/W	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)		0.5		
Package Marking and Ordering Information					
Device Marking		Device	Reel Size	Tape width	Quantity
FDS7098N3 FDS70		FDS7098N3	13"	12mm	2500 units

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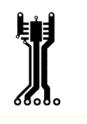
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics				•	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		27		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V$, $V_{GS} = 0 V$			10	μA
I _{GSS}	Gate–Body Leakage	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_{D} = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-6		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			7.5 9.5 11	9 12 14	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = 10 V$, $I_{D} = 14 A$		62		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		1587		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		385		pF
C _{rss}	Reverse Transfer Capacitance			154		pF
R _G	Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz		1.4		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V, I_D = 1 A,$		11	20	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		13	23	ns
t _{d(off)}	Turn–Off Delay Time	-		27	43	ns
t _f	Turn–Off Fall Time	-		15	27	ns
Qg	Total Gate Charge	$V_{DS} = 15 V$, $I_{D} = 14 A$,		16	22	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5.0 V 5			nC	
Q _{gd}	Gate–Drain Charge			6		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				2.5	А
t _{RR}	Reverse Recovery Time	I _F = 14 A,		16		ns
Q _{RR}	Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$ (Note 2)		26		nC
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 2.5 A$ (Note 2)		0.7	1.2	V

Notes:

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



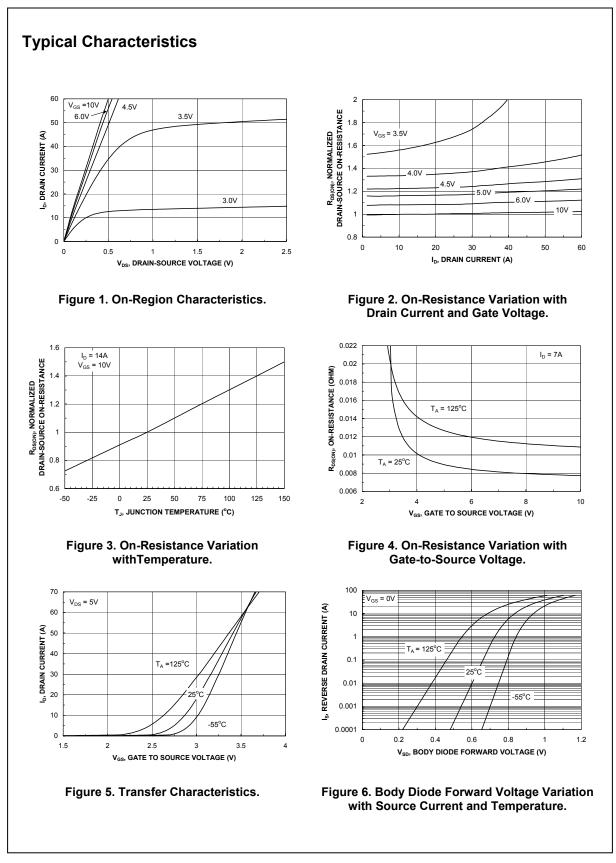
a)	40°C/W when
	mounted on a 1in ² pad
	of 2 oz copper

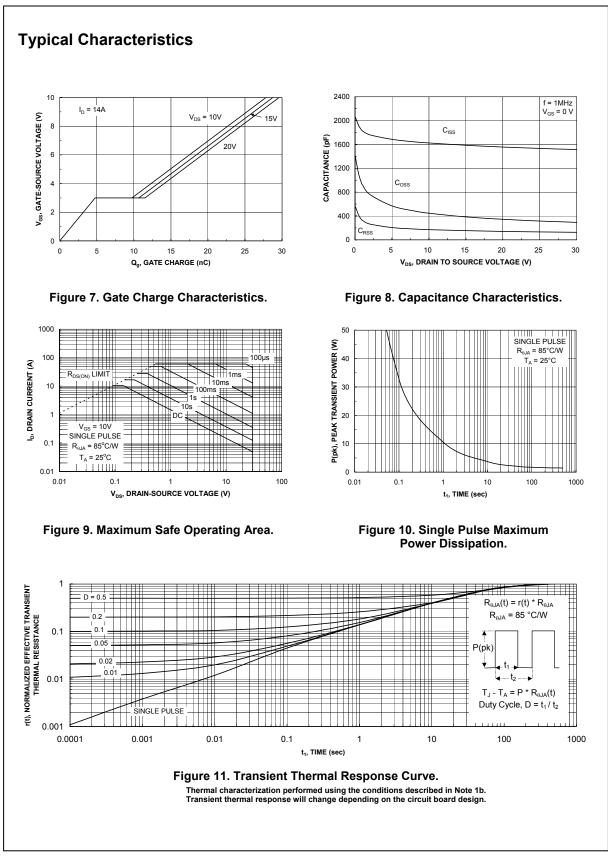


b) 85°C/W when mounted on a minimum pad of 2 oz copper

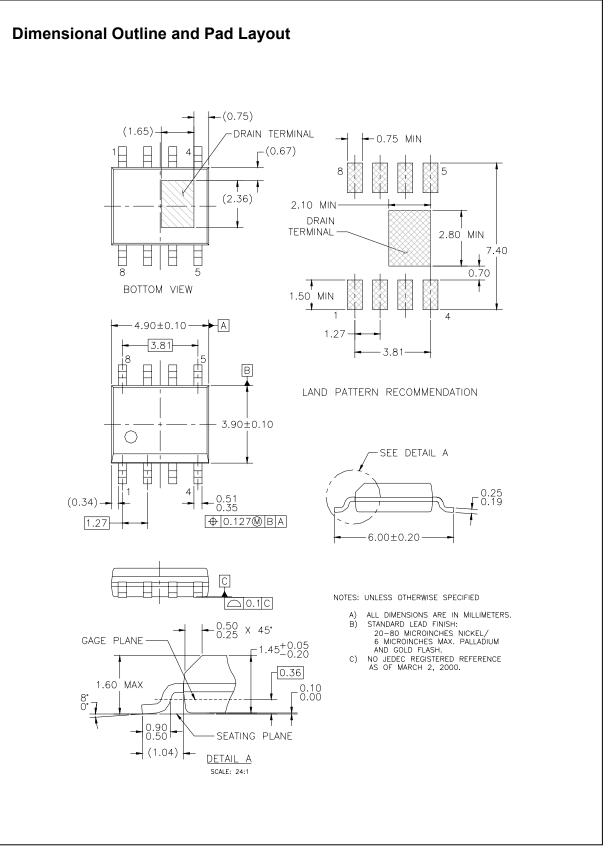
Scale 1 : 1 on letter size paper

FDS7098N3





FDS7098N3 Rev C (W)



FDS7098N3 Rev C (W)

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EnSigna™	<i>i-Lo</i> ™	OCX™	RapidConnect™	UHC™
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